Si3993CDV

RoHS

COMPLIANT

HALOGEN

FREE

 S_2

a

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Marking code: MJ

PRODUCT SUMMARY					
V _{DS} (V)	-30				
$R_{DS(on)}$ max. (Ω) at V_{GS} = -10 V	0.111				
$R_{DS(on)}$ max. (Ω) at V_{GS} = -4.5 V	0.188				
Q _g typ. (nC)	2.7				
I _D (A) ^a	-2.9				
Configuration	Dual				

FEATURES

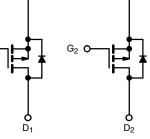
Dual P-Channel 30 V (D-S) MOSFET

- TrenchFET[®] power MOSFET
- 100 % R_g tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

C

APPLICATIONS

- Load switch for portable applications
- Battery switch for portable devices G1
- Computers
 Bus switch
 - Load switch



S-

P-Channel MOSFET P-Channel MOSFET

ORDERING INFORMATION

Package	TSOP-6			
Lead (Pb)-free and halogen-free	Si3993CDV-T1-GE3			

ABSOLUTE MAXIMUM RATINGS ($T_A = 25 \degree C$, unless otherwise noted)				
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V _{DS}	-30	N
Gate-source voltage		V _{GS}	± 20	V
	T _C = 25 °C		-2.9	
	T _C = 70 °C	1.	-2.3	
Continuous drain current (T _J = 150 °C)	T _A = 25 °C	I _D	-2.6 ^{b, c}	
	T _A = 70 °C		-2.1 ^{b, c}	А
Pulsed drain current		I _{DM}	-8	
	T _C = 25 °C		-1.17	
Continuous source-drain diode current	T _A = 25 °C	- I _S	-0.95 ^{b, c}	
	T _C = 25 °C		1.4	
Maximum power dissipation	T _C = 70 °C		0.9	10/
	T _A = 25 °C	P _D	1.14 ^{b, c}	W
	T _A = 70 °C	1	0.73 ^{b, c}	
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	°C

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient b, d	t ≤ 5 s	R _{thJA}	93	110	°C/W
Maximum junction-to-foot	Steady state	R _{thJF}	75	90	C/W

Notes

a. $T_C = 25 \ ^{\circ}C$

b. Surface mounted on 1" x 1" FR4 board

c. t = 5 s

d. Maximum under steady state conditions is 150 °C/W

S11-0240-Rev. A, 14-Feb-11

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PARAMETER SYMBOL TEST CONDITION		TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static						
Drain-source breakdown voltage	V _{DS}	V _{GS} = 0 V, I _D = -250 μA	-30	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$		-	-17	-	mV/°C
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = -250 μA	-	3.5	-	
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$	-1.2	-	-2.2	V
Gate-source leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	-	-	± 100	nA
Zene nete velte en alusia sumont		$V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	1	
Zero gate voltage drain current	IDSS	V_{DS} = -30 V, V_{GS} = 0 V, T_{J} = 55 °C	-	-	10	μA
On-state drain current ^a	I _{D(on)}	$V_{DS} \le -5 \text{ V}, \text{ V}_{GS} = -10 \text{ V}$	-8	-	-	Α
	5	$V_{GS} = -10 \text{ V}, \text{ I}_{D} = -2.5 \text{ A}$	-	0.092	0.111	0
Drain-source on-state resistance ^a	R _{DS(on)}	V _{GS} = -4.5 V, I _D = -1 A	-	0.156	0.188	Ω
Forward transconductance ^a	9 _{fs}	V _{DS} = -15 V, I _D = -2.6 A	-	5	-	S
Dynamic ^b	· 1					
Input capacitance	C _{iss}		-	210	-	
Output capacitance	C _{oss}	$V_{DS} = -15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	45	-	pF
Reverse transfer capacitance	C _{rss}		-	33	-	
Total gate charge	Qg	V_{DS} = -15 V, V_{GS} = -10 V, I_D = -2.6 A	-	5.2	8	1
			-	2.7	4	
Gate-source charge	Q _{gs}	V_{DS} = -15 V, V_{GS} = -4.5 V, I_D = -2.6 A	-	0.94	-	nC
Gate-drain charge	Q _{gd}	1 [1.3	-	1
Gate resistance	R _g	f = 1 MHz	2	7	14	Ω
Turn-on delay time	t _{d(on)}		-	39	59	
Rise time	t _r	$V_{DD} = -15 \text{ V}, \text{ R}_{\text{L}} = 7.1 \Omega$	-	25	38]
Turn-off delay time	t _{d(off)}	$I_D\cong$ -2.1 A, V_{GEN} = -4.5 V, R_g = 1 Ω	-	13	20	
Fall time	t _f		-	9	18	
Turn-on delay time	t _{d(on)}		-	5	10	ns
Rise time	t _r	V_{DD} = -15 V, R_L = 7.1 Ω	-	10	20	
Turn-off delay time	t _{d(off)}	$I_D \cong$ -2.1 A, V_{GEN} = -10 V, R_g = 1 Ω	-	14	21	1
Fall time	t _f		-	7	14	
Drain-Source Body Diode Characterist	cs					
Continuous source-drain diode current	Is	T _C = 25 °C	-	-	1.17	•
Pulse diode forward current	I _{SM}		-	-	8	A
Body diode voltage	V _{SD}	I _S = -2.1 A, V _{GS} = 0 V	-	0.85	1.2	V
Body diode reverse recovery time	t _{rr}		-	13	20	ns
Body diode reverse recovery charge	Q _{rr}	I _F = -2.1 A, di/dt = 100 A/μs,	-	6	12	nC
Reverse recovery fall time	ta	$T_J = 25 \text{ °C}$	-	9	-	
Reverse recovery rise time	t _b		_	4	_	ns

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

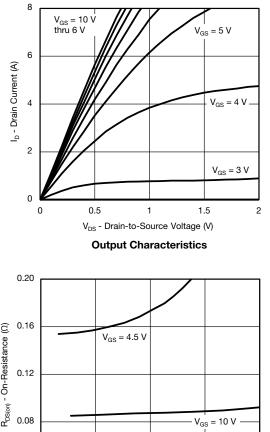
b. Guaranteed by design, not subject to production testing

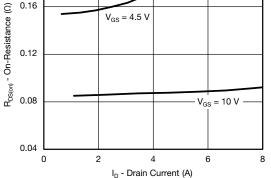
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



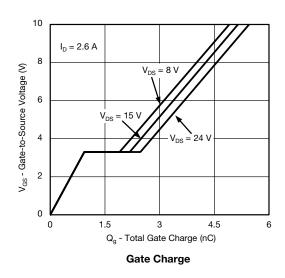
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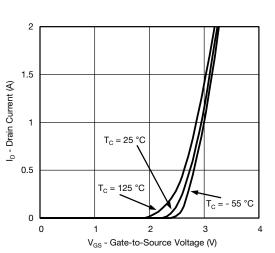
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



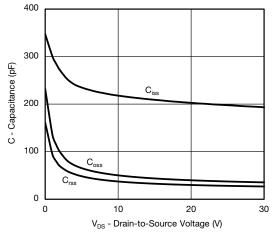


On-Resistance vs. Drain Current and Gate Voltage

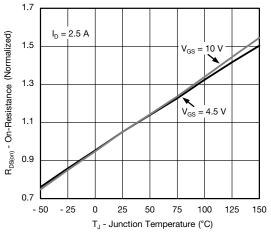




Transfer Characteristics



Capacitance



On-Resistance vs. Junction Temperature

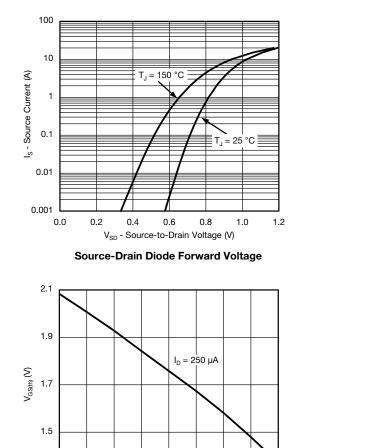
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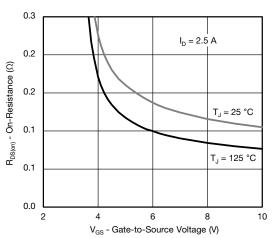
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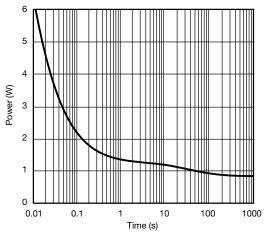
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

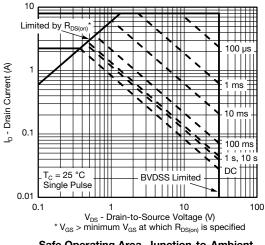




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power (Junction-to-Ambient)



Safe Operating Area, Junction-to-Ambient

1.3

- 50 - 25 0

25

50

T_J - Temperature (°C)

Threshold Voltage

75

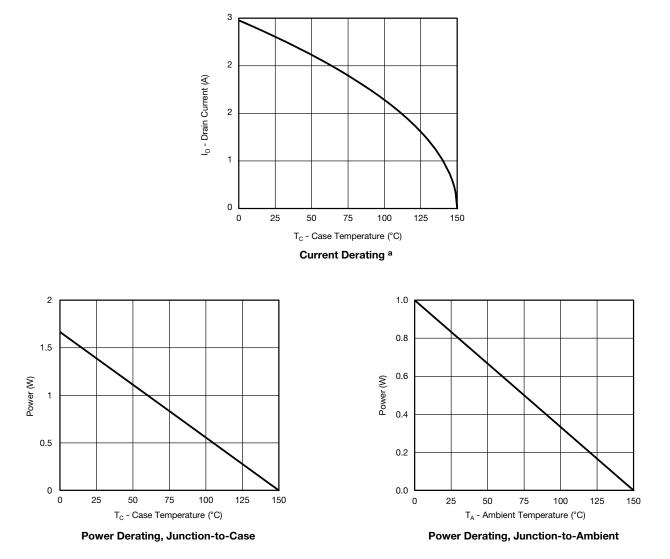
100 125



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Note

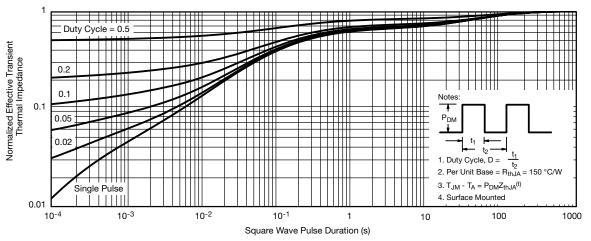
a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



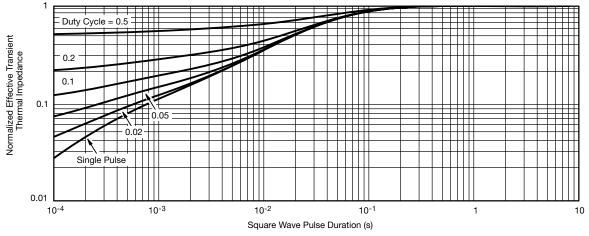
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see <u>www.vishay.com/ppg?67331</u>.



Package Information

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TSOP: 5/6-LEAD JEDEC Part Number: MO-193C









6-LEAD TSOP



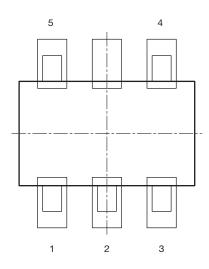
	MILLIMETERS			INCHES					
Dim	Min	Nom	Max	Min	Nom	Max			
Α	0.91	-	1.10	0.036	-	0.043			
A ₁	0.01	-	0.10	0.0004	-	0.004			
A ₂	0.90	-	1.00	0.035	0.038	0.039			
b	0.30	0.32	0.45	0.012	0.013	0.018			
С	0.10	0.15	0.20	0.004	0.006	0.008			
D	2.95	3.05	3.10	0.116	0.120	0.122			
Е	2.70	2.85	2.98	0.106	0.112	0.117			
E ₁	1.55	1.65	1.70	0.061	0.065	0.067			
е	0.95 BSC			0.0374 BSC					
e ₁	1.80	1.90	2.00	0.071	0.075	0.079			
L	0.32	-	0.50	0.012	-	0.020			
L ₁	0.60 Ref				0.024 Ref				
L ₂	0.25 BSC				0.010 BSC				
R	0.10	-	-	0.004	-	-			
θ	0°	4°	8°	0°	4°	8°			
θ_1	7° Nom				7° Nom				
		ev. I, 18-Dec	c-06			ECN: C-06593-Rev. I, 18-Dec-06 DWG: 5540			

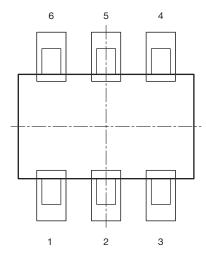
PAD Pattern



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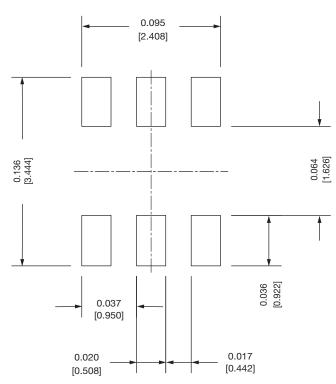
Recommended Land Pattern For TSOP-5L / TSOP-6L





TSOP 5L





Note

• All dimensions are in inches (millimeter)

ECN: C22-0860-Rev. B, 24-Oct-2022	
DWG: 3010	



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